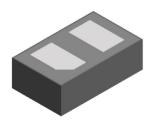


## PESDRC2FD12VBH

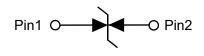
**Bi-directional 12V Low Capacitance ESD Protector** 

#### **Description**

The PESDRC2FD12VBH protects sensitive semiconductor components from damage or upset due to electrostatic discharge (ESD) and other voltage induced transient events. They feature large cross-sectional area junctions for conducting high transient currents, offer desirable electrical characteristics for board level protection, such as fast response time, low operating voltage. It gives designer the flexibility to protect one bi-directional line in applications where arrays are not practical.







**Circuit Diagram** 

#### Feature

- 135W peak pulse power per line (t<sub>P</sub> = 8/20µs)
- Low clamping voltage
- DFN1006-2L package
- Response time is typically < 1 ns</p>
- Bidirectional configurations
- RoHS compliant
- Transient protection for data lines to IEC 61000-4-2(ESD) ±30kV(air), ± 30kV(contact); IEC 61000-4-5 (Lightning) 18A (8/20us)



#### warking (top view

#### **Applications**

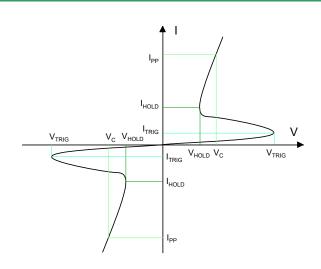
- Cellular phones
- Portable devices
- Digital cameras
- Power supplies
- ▶ USB 2.0 and USB 3.0
- HDMI 1.3 and HDMI 1.4

#### **Mechanical Characteristics**

- Mounting position: Any
- Qualified max reflow temperature:260°C
- Device meets MSL 1 requirements
- DFN1006-2L without plating

#### **Electronics Parameter**

Symbol	Parameter		
V <sub>RWM</sub>	Peak Reverse Working Voltage		
I <sub>R</sub>	Reverse Leakage Current @ V <sub>RWM</sub>		
V <sub>BR</sub>	Breakdown Voltage @ I <sub>T</sub>		
Ι <sub>Τ</sub>	Test Current		
I <sub>PP</sub>	Maximum Reverse Peak Pulse Current		
V <sub>c</sub>	Clamping Voltage @ I <sub>PP</sub>		
I <sub>TRIG</sub>	Reverse Trigger Current		
V <sub>TRIG</sub>	Reverse Trigger Voltage		
I <sub>HOLD</sub>	Reverse Holding Current		
V <sub>HOLD</sub>	Reverse Holding Voltage		



### Electrical characteristics per line@25°C (unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Units
Peak Reverse Working Voltage	V <sub>RWM</sub>	-	-12	-	12	V
Breakdown Voltage	V <sub>BR</sub>	l <sub>t</sub> = 1mA	14	-	18	V
Reverse Leakage Current	I <sub>R</sub>	V <sub>RWM</sub> = 12V	-	-	1.0	μA
Clamping Voltage	V <sub>c</sub>	I <sub>PP</sub> = 18A,t <sub>P</sub> = 8/20μs	-	7.5	9.0	V
Junction Capacitance	CJ	V <sub>R</sub> = 0V,f = 1MHz	-	0.8	1.3	pF

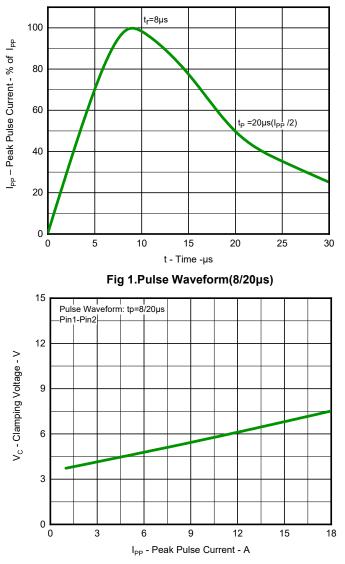
# Absolute maximum rating@25°C

Rating	Symbol	Value	Units
Peak Pulse Power ( t <sub>P</sub> = 8/20µs )	P <sub>PP</sub>	135	W
Peak Pulse Current ( t <sub>P</sub> = 8/20µs )	I <sub>PP</sub>	18	А
Lead Soldering Temperature	Τ <sub>L</sub>	260 (10 sec)	°C
Junction and Storage Temperature Range	T <sub>J,</sub> T <sub>STG</sub>	-55~+150	°C
ESD Protection-Contact Discharge	V <sub>ESD</sub>	±30	kV
ESD Protection-Air Discharge	V <sub>ESD</sub>	±30	kV

# PESDRC2FD12VBH

# PESDRC2FD12VBH

### Typical Characteristics





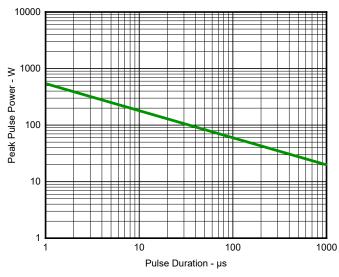
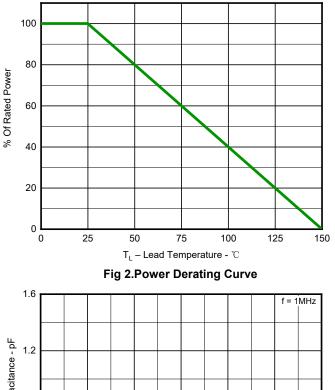
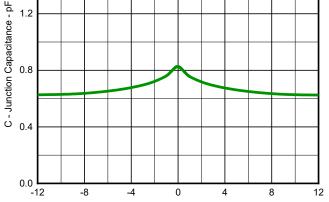


Fig 5. Non Repetitive Peak Pulse Power vs. Pulse Time







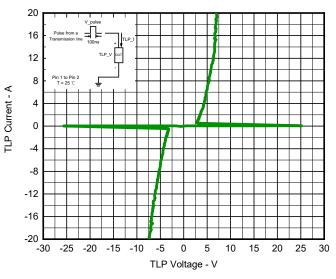
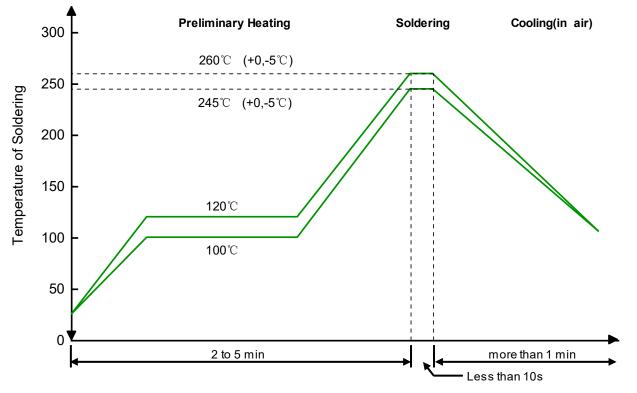


Fig 6. TLP Measurement

PESDRC2FD12VBH

#### **Solder Reflow Recommendation**



Remark: Pb free for 260°C; Pb for 245°C.

## PESDRC2FD12VBH

### **ESD** Protector

#### PCB Design

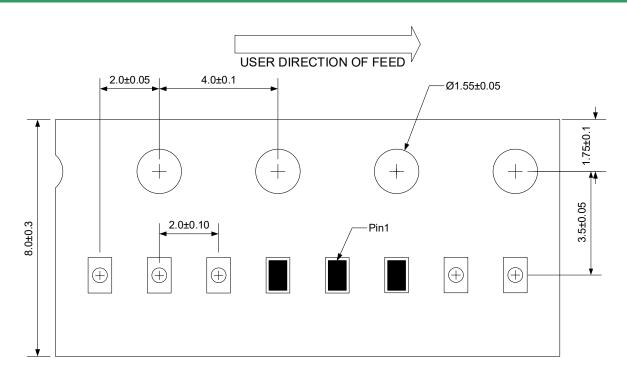
For TVS diodes a low-ohmic and low-inductive path to chassis earth is absolutely mandatory in order to achieve good ESD protection. Novices in the area of ESD protection should take following suggestions to heart:

- > Do not use stubs, but place the cathode of the TVS diode directly on the signal trace.
- > Do not make false economies and save copper for the ground connection.
- > Place via holes to ground as close as possible to the anode of the TVS diode.
- ➢ Use as many via holes as possible for the ground connection.
- > Keep the length of via holes in mind! The longer the more inductance they will have.

#### **Ordering information**

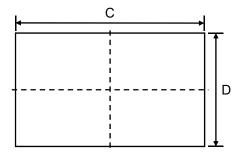
Device	ce Package Reel		Shipping	
PESDRC2FD12VBH	DFN1006-2L (Pb-Free)	7"	10000 / Tape & Reel	

#### Load with information

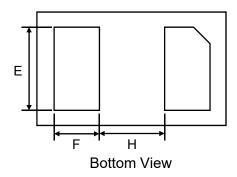


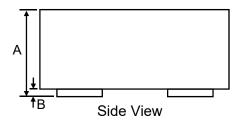
# PESDRC2FD12VBH

## Product dimension (DFN1006-2L)

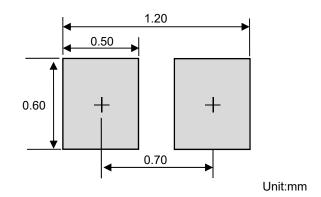








Dim	Millin	neters	Inches		
Dim	Min	Max	Min	Max	
А	0.340	0.500	0.013	0.020	
В	0.000	0.050	0.000	0.002	
С	0.950	1.080	0.037	0.043	
D	0.550	0.680	0.022	0.027	
E	0.400	0.600	0.016	0.024	
F	0.200	0.300	0.008	0.012	
Н	0.400 Typ.		0.015 Typ.		



Suggested PCB Layout

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